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OCT 17 2004

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

5 Applicant(s): Kuo-Ming Chen and Hung-Min Liu

Examiner: LEBENTRITT, MICHAEL

Filing Date: 10/31/2002 Art Unit: 2824

App. No.: 10/065,568 Docket No.: NAUP0482USA

10 Title: SOLDER BUMP STRUCTURE AND LASER REPAIR PROCESS  
FOR MEMORY DEVICE

To: Commissioner for Patents

P.O. BOX 1450

15 Alexandria, VA 22313-1450

Subject: Request for Continued Examination (RCE) in  
response to the final Office action mailed  
07/23/2004

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**INTRODUCTORY COMMENTS**

In response to the Office action identified above,  
a request for continued examination (RCE) is made and  
5 the above-identified application is to be amended as  
indicated in the following sections. No new matter has  
been introduced by these amendments. A continued  
examination and consideration of all amendments are  
politely requested.

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